

NCE70N100I-VB Datasheet N-Channel 100-V (D-S), 175 °C MOSFET

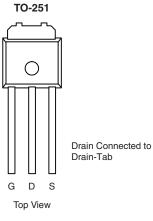
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
100	0.0125 at V _{GS} = 10 V	65	48 nC			

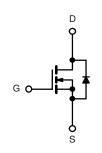
FEATURES

- Trench Power MOSFET
- 100 % Rg Tested
- 100 % UIS Tested

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	s otherwise no	oted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		65 ^a		
Continuous Drain Current (T_{I} = 150 °C)	T _C = 100 °C		52		
Continuous Drain Current $(T_j = 150^{\circ} C)$	T _A = 25 °C	I _D	8.2 ^b		
	T _A = 100 °C		5.8 ^b	А	
Pulsed Drain Current		I _{DM}	200		
Continuous Source-Drain Diode Current	T _C = 25 °C	1	65 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.0 ^b		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	48		
Avalanche Energy	L = 0.1 mm	E _{AS}	121	mJ	
	T _C = 25 °C	– P _D	156.4		
Maximum Power Dissipation	T _C = 100 °C		78.2	w	
Maximum Fower Dissipation	T _A = 25 °C		3.0 ^b	~~~~	
	T _A = 100 °C		1.5 ^b		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.85	1.1		

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.



SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	· · · · · ·				•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 uA		110		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μΑ		- 12.5		mv/-C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2.5		5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	1	V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	50			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A		0.0125		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2800		pF	
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		260			
Reverse Transfer Capacitance	C _{rss}			100			
Total Gate Charge	Qg			48	75	nC	
Gate-Source Charge	Q _{qs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		16			
Gate-Drain Charge	Q _{gd}			13			
Gate Resistance	R _g	f = 1 MHz		1.6	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			12	20		
Rise Time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{1} = 1.0 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		18	35	ns	
Fall Time	t _f			8	15		
Drain-Source Body Diode Characteris	tics	· · · · · ·				•	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			50	•	
Pulse Diode Forward Current ^a	I _{SM}				100	A	
Body Diode Voltage	V _{SD}	I _S = 15 A		0.85	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			80	120	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			160	240	nC	
Reverse Recovery Fall Time	t _a	$I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		57			
Reverse Recovery Rise Time	t _b			23		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

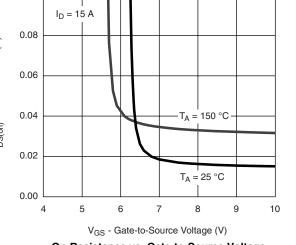
emi

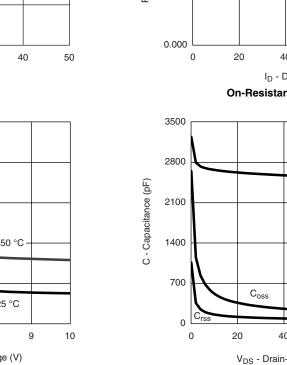
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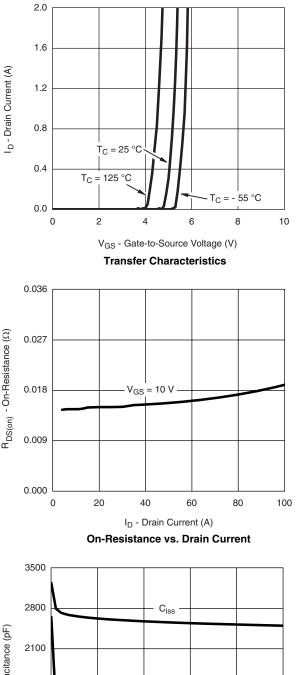
100 $V_{GS} = 10$ thru 8 V 80 $V_{GS} = 7 V$ I_D - Drain Current (A) I_D - Drain Current (A) 60 40 20 $V_{GS} = 6 V$ 0 2 3 4 0 1 5 V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics** 75 55 °C $T_C = -$ 60 $R_{DS(on)}$ - On-Resistance (Ω) g_{fs} - Transconductance (S) T_C = 25 °C 45 T_C = 125 °C 30 15 0 0 10 20 30 40 50 I_D - Drain Current (A) Transconductance 0.10 $I_{D} = 15 \text{ A}$ 0.08 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) C - Capacitance (pF) 0.06 0.04 T_A = 150 °C 0.02 T_A = 25 °C 0.00 4 5 6 7 8 9 10 V_{GS} - Gate-to-Source Voltage (V)

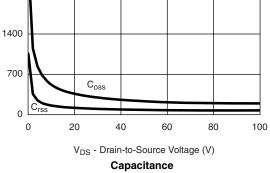
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





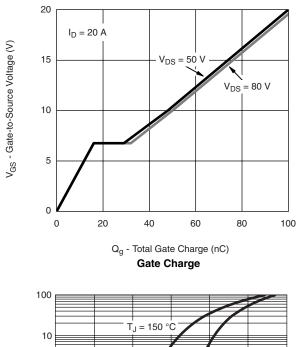


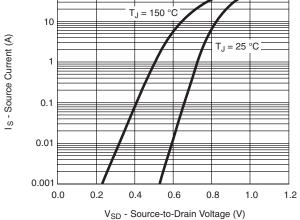


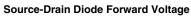


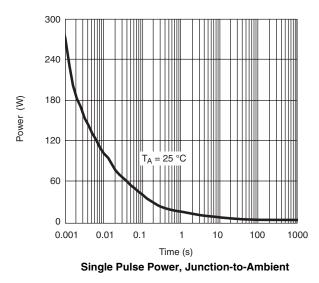


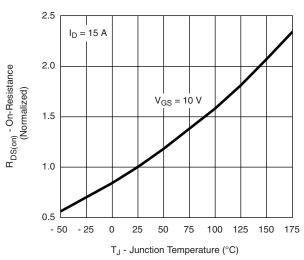




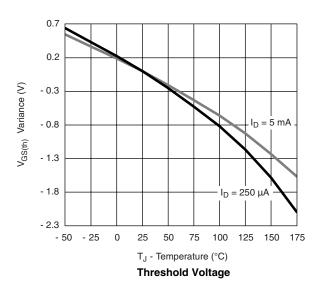


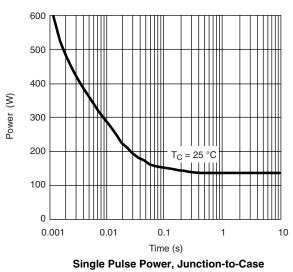






On-Resistance vs. Junction Temperature







10 us.

100 us

ms 10 ms

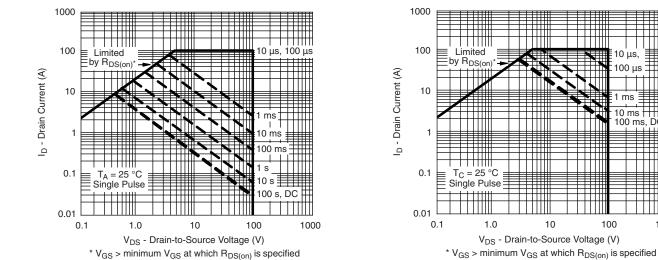
100 ms, D

1000

175

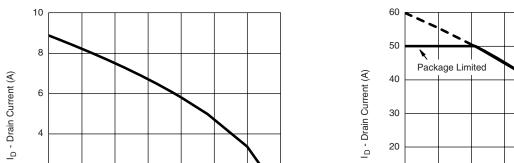
100

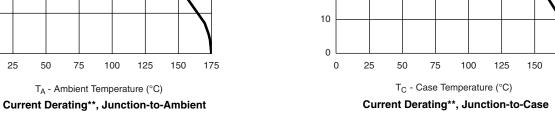
Safe Operating Area, Junction-to-Case



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Safe Operating Area, Junction-to-Ambient





** The power dissipation P_D is based on T_{J(max)} = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

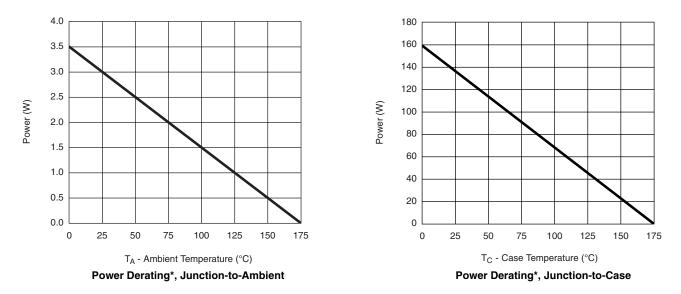
2

0 0

25

50

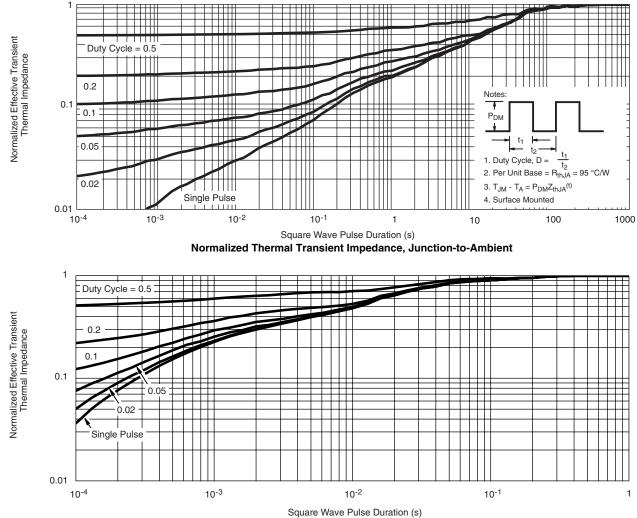




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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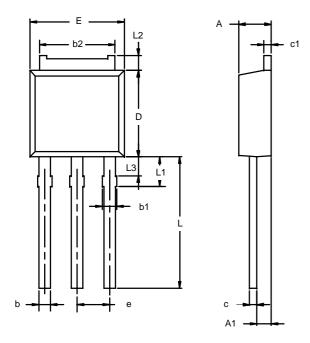


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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